

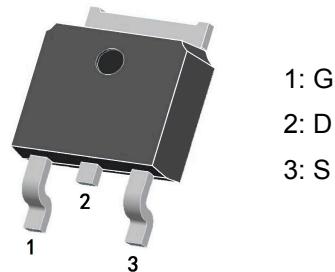
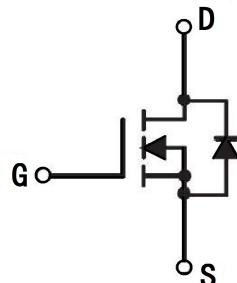
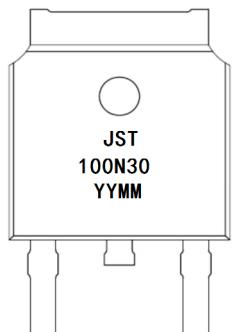
30V N-Channel Mosfet

FEATURES

- RDS(ON) < 4mΩ @ VGS = 10V
- RDS(ON) < 6mΩ @ VGS = 4.5V

APPLICATIONS

- Load Switch
- PWM Application
- Power management

TO-252-2L**MARKING****N-CHANNEL MOSFET****YYMM:Date Code(year&month)****Absolute Maximum Ratings** ($T_c=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | | Max. | Units |
|-----------------|---|---------------------------|-------------|---------------------------|
| V_{DSS} | Drain-Source Voltage | | 30 | V |
| V_{GSS} | Gate-Source Voltage | | ± 20 | V |
| I_D | Continuous Drain Current | $T_c = 25^\circ\text{C}$ | 100 | A |
| | | $T_c = 100^\circ\text{C}$ | 65 | A |
| I_{DM} | Pulsed Drain Current ^{note1} | | 400 | A |
| E_{AS} | Single Pulsed Avalanche Energy ^{note2} | | 180 | mJ |
| P_D | Power Dissipation | $T_c = 25^\circ\text{C}$ | 88 | W |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | | 1.7 | $^\circ\text{C}/\text{W}$ |
| T_J, T_{STG} | Operating and Storage Temperature Range | | -55 to +175 | $^\circ\text{C}$ |

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Units |
|---|--|---|------|------|-----------|------------------|
| Off Characteristic | | | | | | |
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}, I_D=250\mu\text{A}$ | 30 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=30\text{V}, V_{GS}=0\text{V},$ | - | - | 1.0 | μA |
| I_{GSS} | Gate to Body Leakage Current | $V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$ | - | - | ± 100 | nA |
| On Characteristics | | | | | | |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$ | 1.0 | 1.6 | 2.5 | V |
| $R_{DS(\text{on})}$ | Static Drain-Source on-Resistance note3 | $V_{GS}=10\text{V}, I_D=24\text{A}$ | - | 3.1 | 4 | $\text{m}\Omega$ |
| | | $V_{GS}=4.5\text{V}, I_D=12\text{A}$ | - | 4.5 | 6 | |
| g_{FS} | Forward Transconductance | $V_{DS}=10\text{V}, I_D=10\text{A}$ | - | 15.5 | - | S |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS}=25\text{V}, V_{GS}=0\text{V},$ $f=1.0\text{MHz}$ | - | 2200 | - | pF |
| C_{oss} | Output Capacitance | | - | 280 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 177 | - | pF |
| Q_g | Total Gate Charge | $V_{DS}=15\text{V}, I_D=24\text{A},$ $V_{GS}=10\text{V}$ | - | 42 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 4 | - | nC |
| Q_{gd} | Gate-Drain("Miller") Charge | | - | 13 | - | nC |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD}=15\text{V},$ $I_D=15\text{A}, R_{GEN}=3.3\Omega,$ $V_{GS}=10\text{V}$ | - | 12.6 | - | ns |
| t_r | Turn-on Rise Time | | - | 19.5 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 42.8 | - | ns |
| t_f | Turn-off Fall Time | | - | 13.2 | - | ns |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_s | Maximum Continuous Drain to Source Diode Forward Current | - | - | 100 | - | A |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | - | - | 400 | - | A |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS}=0\text{V}, I_s=30\text{A}$ | - | - | 1.2 | V |
| trr | Body Diode Reverse Recovery Time | $I_F=30\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | - | 19 | - | ns |
| Qrr | Body Diode Reverse Recovery Charge | | - | 11 | - | nC |

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition: $T_J=25^\circ\text{C}, V_{DD}=25\text{V}, V_G=10\text{V}, R_G=25\Omega$

3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$

Typical Performance Characteristics

Figure 1: Output Characteristics

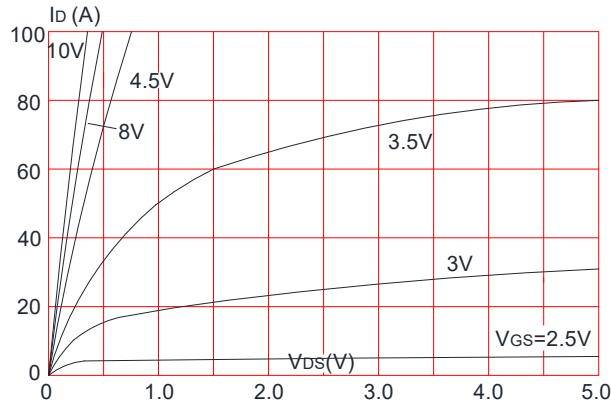


Figure 3: On-resistance vs. Drain Current

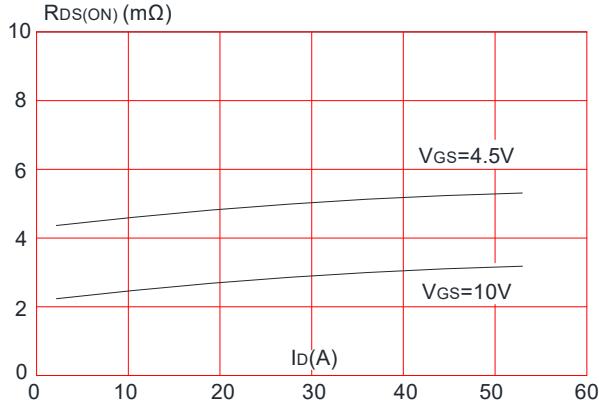


Figure 5: Gate Charge Characteristics

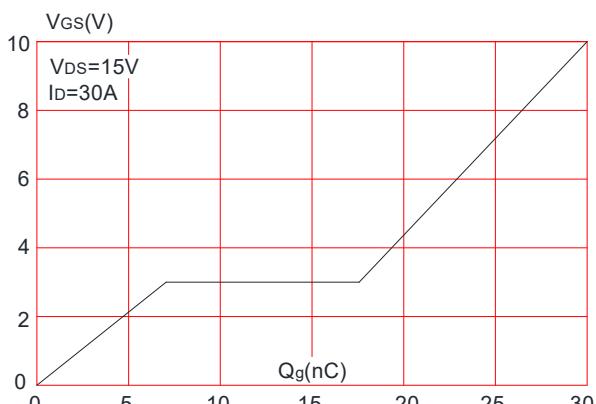


Figure 2: Typical Transfer Characteristics

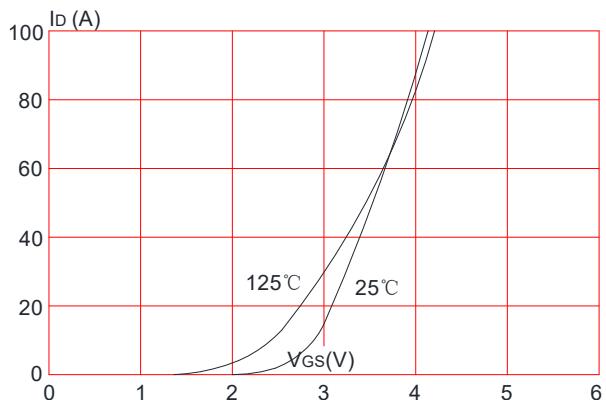


Figure 4: Body Diode Characteristics

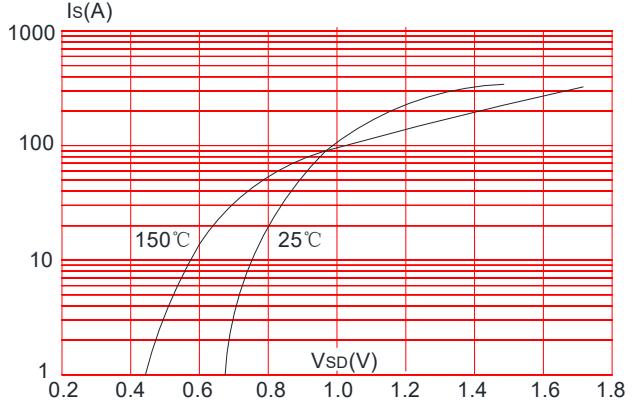


Figure 6: Capacitance Characteristics

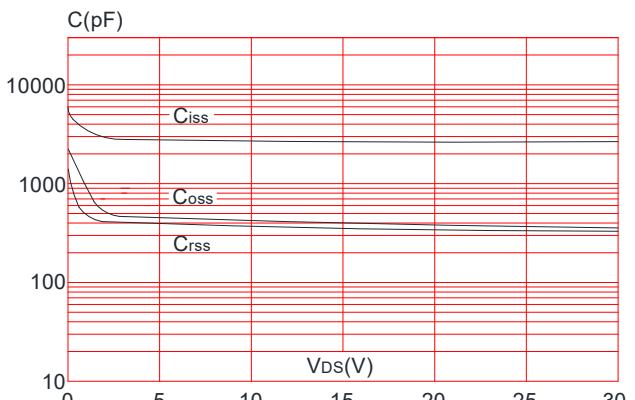


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

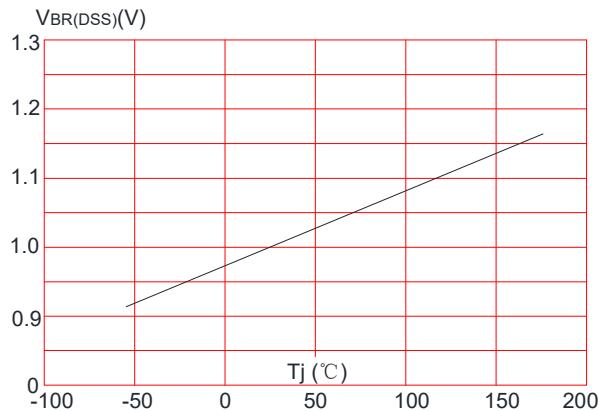


Figure 8: Normalized on Resistance vs. Junction Temperature

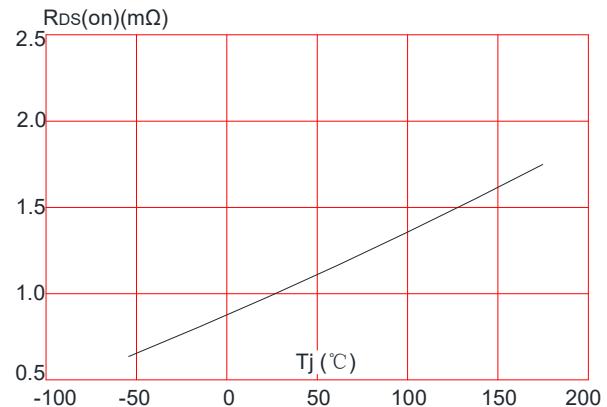


Figure 9: Maximum Safe Operating Area

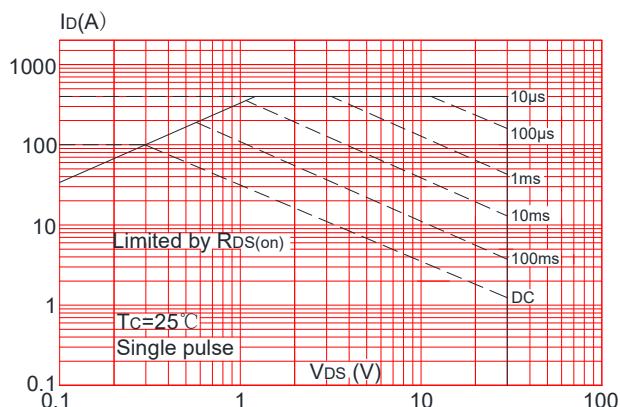


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

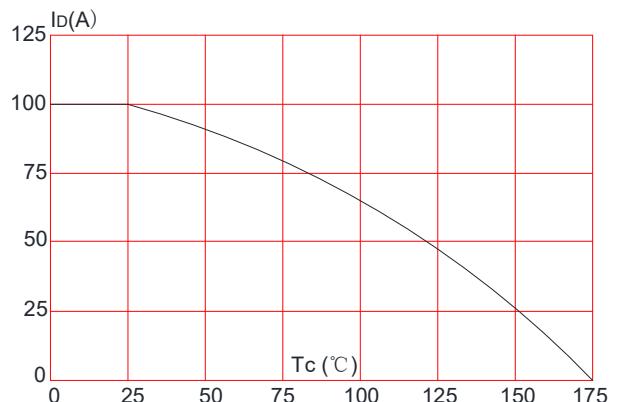
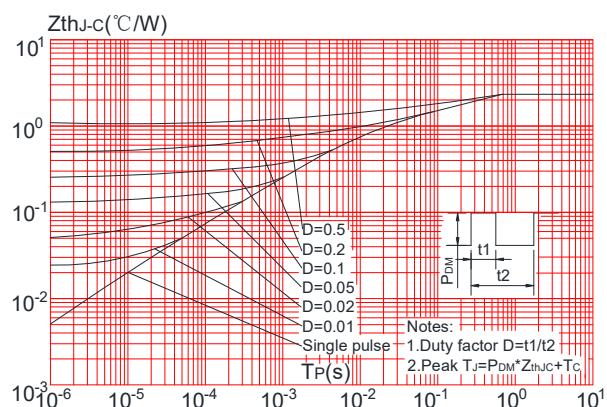
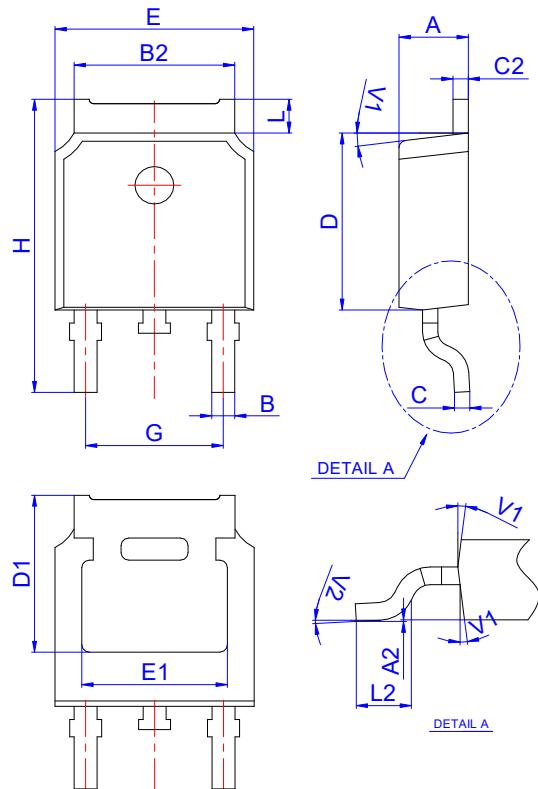


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case



TO-252 PACKAGE OUTLINE DRAWING



| Symbols | Dimensions | | | | | |
|---------|-------------|------|-------|----------|------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 2.10 | | 2.50 | 0.083 | | 0.098 |
| A2 | 0 | | 0.10 | 0 | | 0.004 |
| B | 0.66 | | 0.86 | 0.026 | | 0.034 |
| B2 | 5.18 | | 5.48 | 0.202 | | 0.216 |
| C | 0.40 | | 0.60 | 0.016 | | 0.024 |
| C2 | 0.44 | | 0.58 | 0.017 | | 0.023 |
| D | 5.90 | | 6.30 | 0.232 | | 0.248 |
| D1 | 5.30REF | | | 0.209REF | | |
| E | 6.40 | | 6.80 | 0.252 | | 0.268 |
| E1 | 4.63 | | | 0.182 | | |
| G | 4.47 | | 4.67 | 0.176 | | 0.184 |
| H | 9.50 | | 10.70 | 0.374 | | 0.421 |
| L | 1.09 | | 1.21 | 0.043 | | 0.048 |
| L2 | 1.35 | | 1.65 | 0.053 | | 0.065 |
| V1 | | 7° | | | 7° | |
| V2 | 0° | | 6° | 0° | | 6° |